

## EAST Search History

S3	35	(216/45).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/18 12:04
S4	196	(216/44).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/18 12:04
S5	442	(216/56).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/18 12:05
S6	1955	216/12,41,45,44,56.ccls. and mask\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/18 12:05
S7	1356	216/12,41,45,44,56.ccls. and mask\$3 and @ad<="20030225"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/18 12:12
S8	122	216/12,41,45,44,56.ccls. and mask\$3 and @ad<="20030225" and (tilt\$4 or inclin\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/18 12:15

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	(semiconductor and bump and barrier and (perforat\$4 or permeable or porous or permibility) and (print adj mask\$4) and @ad<="20030225" and (tilt\$4 or inclin\$4)).CLM.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 07:39
L2	0	(semiconductor and bump and barrier and (perforat\$4 or permeable or porous or permibility) and (print adj mask\$4) and (tilt\$4 or inclin\$4)).CLM.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 07:39
L3	0	(semiconductor and bump and barrier and (perforat\$4 or permeable or porous or permibility) and (print\$4 adj mask\$4) and (tilt\$4 or inclin\$4)).CLM.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 07:39
L4	42	257/E21.023.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 07:43
L5	365	257/E21.039.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/22 07:43
S1	457	(216/12).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/18 12:04
S2	1882	(216/41).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/01/18 12:04